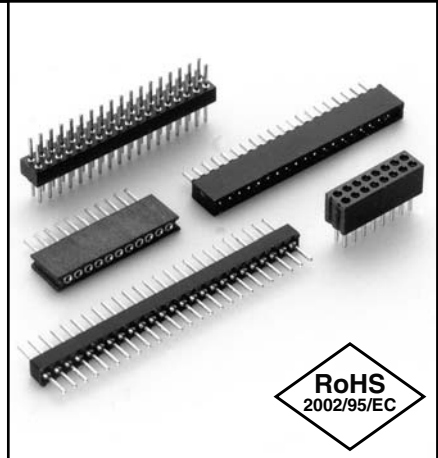


Fig. 1

- Series 850 single and double row interconnects have .050" pin spacing & permit board stacking as low as .248".
- Pin headers have .016" dia. pins (MM #4006-0). See page 175 for details.
- MM #0467 and MM #4890 receptacles use Hi-Rel, 3-finger BeCu #11 contacts rated at 3 amps. (#11 contact accepts pin diameters from .015"-.020"). See pages 129 and 131 for details.
- Insulators are high temp. thermoplastic, suitable for all soldering operations.



Ordering Information

Fig. 1	Single Row	.087" Profile Pin Header
	850-XX-0__-10-001000	
	Specify # of pins	└───> 01-50

Fig. 2	Double Row	.075" Profile Pin Header
	852-XX-__-10-001000	
	Specify # of pins	└───> 002-100

For Electrical, Mechanical & Environmental Data, See pg. 4

XX=Plating Code See Below

For RoHS compliance select ◇ plating code.

SPECIFY PLATING CODE XX=	10◇	90	40◇	
Pin Plating	10μ" Au	200μ" Sn/Pb	200μ" Sn	

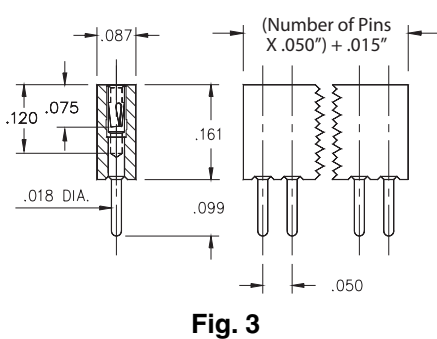


Fig. 3

Fig. 3	Single Row	.161" Profile Socket
	851-XX-0__-10-001000	
	Specify # of pins	└───> 01-50

Fig. 4	Double Row	.161" Profile Socket
	853-XX-__-10-001000	
	Specify # of pins	└───> 002-100

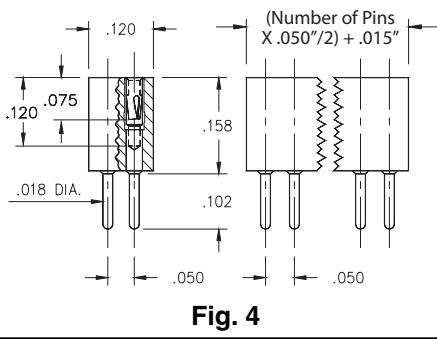


Fig. 4

Fig. 5	Single Row	.185" Profile Socket
	851-XX-0__-10-002000	
	Specify # of pins	└───> 01-77

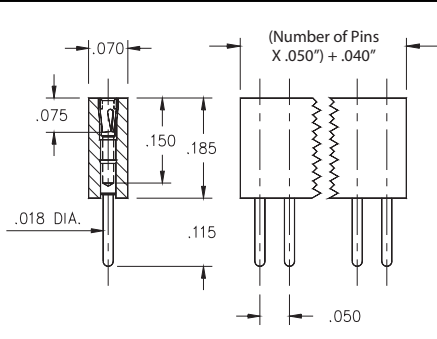


Fig. 5

For Electrical, Mechanical & Environmental Data, See pg. 4

XX=Plating Code See Below

For RoHS compliance select ◇ plating code.

SPECIFY PLATING CODE XX=		93	99	43◇	
Sleeve (Pin)		200μ" Sn/Pb	200μ" Sn/Pb	200μ" Sn	
Contact (Clip)		30μ" Au	200μ" Sn/Pb	30μ" Au	